

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/392,073
Priority Filing Date September 8, 1999
Inventor Rickie C. Lake, et al
Assignee Micron Technology, Inc.
Priority Group Art Unit 1751
Priority Examiner D. Hamlin
Attorney's Docket No. MI40-327
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive Adhesive
Connection

#2a
NEAL

PRELIMINARY AMENDMENT

To: Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

From: James E. Lake (Tel. 509-624-4276; Fax 509-838-3424)
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AMENDMENTS

In the Specification

Page 1, after the title, insert:

-CROSS REFERENCE TO RELATED APPLICATION

This patent resulted from a Continuation of U.S. Patent Application Serial
No. 09/392,073, filed September 8, 1999, which is a Divisional of U.S. Patent
Application Serial No. 09/032,262, filed February 27, 1998.--

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